

Features

- 1515 with integrated high quality constant current IC and RGB LED chip.
- Built-in IC, with high precision of constant current and internal RGB chips spectral processing in advance.
- Single line data transmission (return to zero code).
- Specific Shaping Transmit Technology number of LED stacked is not restricted.
- Cascading Enhancement Technology any 2 LED spacing can be up to 10 meters
- Data transfer rate of 800 kbp/s at 30 frames per second.
- RGB output port PWM control can achieve 256 grey level adjustments.
- Upon powering up, IC performs self-inspection then lights connection on the pin B lamp.
- SA-I Anti-interference patent technology for single line data transmission.
- Built-in power supply reverse connects protection module, reversed power input will not damage the IC.

Description

The IN-PI15TAT5R5G5B is 1.5*1.5*0.65mm RGB LED with integrated IC. It is a SMD type LED which can be used in various applications.

Applications

- Full color LED string light
- LED full color module
- LED guardrail tube
- LED scene lighting
- LED point light
- LED pixel screen
- LED shaped screen



Package Outline Dimensions & Pin Configuration



Pin Configuration

Number	Symbol	Function Description				
1	DIN	Control data signal input				
2	VDD	Power supply LED				
3	DOUT	Control data signal output				
4	GND	Ground				

Recommended Dimensions for PCB



Notes:

1. Dimension in millimeter, tolerance is $\pm 0.1 \text{mm}$ unless otherwise noted.



Absolute Maximum Rating (Ta = 25 °C, VSS=0V)

Parameter	Symbol	Range	Unit
Power supply voltage	Vod	+3.7~+5.5	V
Logic input voltage	-0.5 ~VDD+0.5	V	
Operating temperature	Торт	-40 ~ +80	°C
Storage temperature	Тѕтд	-40 ~ +80	°C
ESD pressure (HBM)	Vesd	2K	V
ESD pressure (DM)	Vesd	200	V

LED Characteristics (Ta = 25°C)

Color	IN-PI15TA	T5R5G5B
Color	Wavelength(nm)	Light Intensity(mcd)
Red	620-630	200-350
Green	515-530	500-700
Blue	460-475	100-200



Recommended Operating Ranges (unless otherwise specified, Ta= -20 ~ +70 °C, VDD=4.5 ~ 5.5V, VSS=0V)

Parameter	Symbol	Symbol Min. Typ. Max Unit			Test conditions	
The chip supply voltage	V _{DD}	-	5.2	-	V	-
	Vıн	0.7*VDD	-	-	V	VDD=5.0V
The signal input flip threshold	V _{IL}	-	-	0.3*VDD	V	VDD=5.0V
The frequency of PWM	F _{PWM}	-	1.2	-	KHZ	-
Static power consumption	I _{DD}	-	1	-	mA	-



Switching Characteristics (VCC=5V, Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max	Unit	Test conditions	
The speed of data transmission	fDIN	-	800	-	KHZ	The duty ratio of 67% (data 1)	
DOLIT transmission dolou	T _{PLH}	-	-	500	ns	DIN→DOUT	
DOUT transmission delay	T _{PHL}	-	-	500	ns	DIN→DOOT	
L Biss/Drop Time	T _r	-	100	-	ns	VDS=1.5	
Ι _{ουτ} Rise/Drop Time	Tf	-	100	-	ns	Ι _{ουτ} =5mA	



Timing Waveforms

1. Input Code





2. The data transmission time (TH+TL=1.25µs±600ns):

	Name	Min	Standard Value	Max	Unit
т	Code Period	1.20	-	-	μs
ТОН	0 code, high level time	0.2	0.3	0.4	μs
TOL	0 code, low level time	0.8	-	-	μs
T1H	1 code, high level time	0.58	0.6	1.0	μs
T1L	1 code, low level time	0.2	-	-	μs
Trst	Reset code, low level time	>80	-	-	μs

1. The protocol uses a unipolar zeroing code. Each symbol must have a low level. Each symbol in this protocol starts with a high level. The high time width determines the "0" or "1" code.

- 2. When writing programs, the minimum symbol period is 1.2µs.
- 3. The high time of "0" code and "1" code should be in accordance with the stipulated range in the above table. The low time requirement of "0" code and "1" code is less than 20µs.
- 3. Connection Scheme



4. Data Transfer Format





5. 24-bit data format

G7	G6	G5	G4	G3	G2	G1	G0	R7	R6	R5	R4			
R3	R2	R1	RO	B7	B6	B5	B4	B3 B2 B1						
Mater Isla	Note: high starting in order to condidate (C7, CC, D0)													

Note: high starting, in order to send data (G7 - G6 -B0)

Typical Application Circuit



Product signal input and output must be connected in series with protection resistor R1. R1 depends on the size of the cascade amount, the greater the number of cascades, the smaller R1. Usually the recommended value is typical 500Ω .



Thermal Pad Temperature vs. Relative Light Output



Wavelength Characteristics





Ordering Information

Product	Emission Color	lv (mcd)	Orderable Part Number				
	R	200-350					
IN-PI15TAT5R5G5B	G	500-700	IN-PI15TAT5R5G5B				
	В	100-200					

Label Specifications



Inolux P/N:

I	Ν	PI	-	15	Т	А	Т	(X)	R	(X)	G	(X)	В	-	Х	Х	Х	Х
		Product		Package	Die Qty.	Variation	Orientation	Current	Color	Current	Color	Current	Color			Customized Stamp-off		
Inol	ux	PI- Single trace IC PC- Clock Function IC		15TA = 1.	5 x 1.5 x (pins)	0.65 mm (4	T = Top Mount	P=12mA 5 = 5mA	R = 624 nm	P=12mA 5 = 5mA	G = 520 nm	P=12mA 5 = 5mA	B = 470 nm					

Lot No.:

Z	2 0 1 7				24	001	
Internal Tracker		Year (2017	, 2018,)		Month	Date	Serial



Precautions

Please read the following notes before using the product:

- 1. Storage
- 1.1 Do not open moisture proof bag before the products are ready to use.
- 1.2 Before opening the package, the LEDs should be kept at $30^\circ\!{\rm C}$ or less and 80%RH or less.
- 1.3 The LEDs should be used within a year.
- 1.4 After opening the package, the LEDs should be kept at $30^\circ\!{\rm C}$ or less and 60%RH or less.
- 1.5 The LEDs should be used within 72 hours after opening the package.
- 1.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: $60\pm5^{\circ}$ C for 24 hours.



2. Soldering Condition Recommended soldering conditions:



Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts $_{\rm max}$ to Tp)	3°C/second max.
Preheat: Temperature Min (Ts min)	150° C
Preheat: Temperature Min (Ts _{max})	200 °⊂
Preheat: Time (ts $_{min to}$ ts $_{max}$)	60-180 seconds
Time Maintained Above: Temperature (T_L)	217 °C
Time Maintained Above: Time (t $_{L}$)	60-150 seconds
Peak/Classification Temperature (T P)	240 ℃
Time Within 5°C of Actual Peak Temperature (tp)	<10 seconds
Ramp-Down Rate	6°C/second max.
Time 25 $^\circ\!C$ to Peak Temperature	<6 minutes max.

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.



IN-PI15TAT5R5G5B 1515 RGB LED 4-Pin with Integrated IC

3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260° C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



5. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wristband or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	03-20-2020

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